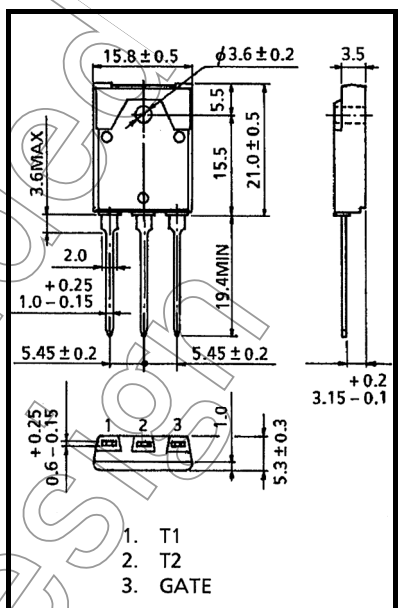
TOSHIBA BI−DIRECTIONAL TRIODE THYRISTOR ILICON PLANAR TYPE

SM25GZ51, SM25JZ51

AC POWER CONTROL APPLICATIONS

- Repetitive Peak Off−State Voltage: V_{DRM} = 400V, 600V
- R.M.S On−State Current: $I_{T\ (RMS)}$ = 25A
- High Commutating (dv / dt): (dv / dt) c = 10V / μs
- Isolation Voltage: V_{Isol} = 1500V AC

Unit: mm



JEDEC	—
JEITA	—
TOSHIBA	13-16A1A

Weight: 5.9 g (typ.)

ABSOLUTE MAXIMUM RATINGS

CHARACTERISTIC		SYMBOL	RATING	UNIT
Repetitive Peak Off−State Voltage	SM25GZ51	V_{DRM}	400	V
	SM25JZ51		600	
R.M.S On−State Current (Full Sine Waveform Tc = 73°C)		$I_{T\ (RMS)}$	25	A
Peak One Cycle Surge On−State Current (Non-Repetitive)		I_{TSM}	230 (50Hz)	A
			253 (60Hz)	
I^2t Limit Value		I^2t	260	A^2s
Critical Rate of Rise of On−State Current (Note 1)		di / dt	50	A / μs
Peak Gate Power Dissipation		P_{GM}	5	W
Average Gate Power Dissipation		$P_{G\ (AV)}$	0.5	W
Peak Gate Voltage		V_{GM}	10	V
Peak Gate Current		I_{GM}	2	A
Junction Temperature		T_j	−40~125	°C
Storage Temperature Range		T_{stg}	−40~125	°C
Isolation Voltage (AC, t = 1 min.)		V_{Isol}	1500	V

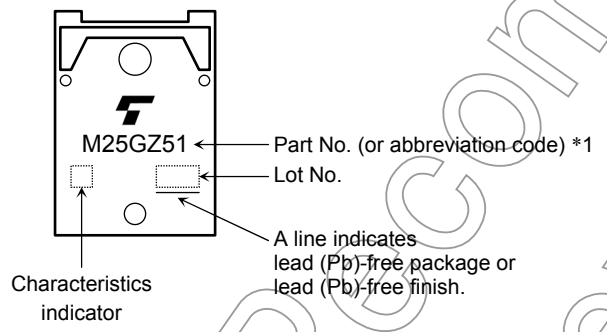
Note 1: di / dt Test Condition
V_{DRM} = 0.5 × Rated
I_{TM} ≤ 40A
t_{gw} ≥ 10μs
t_{gr} ≤ 250ns
i_{gp} = I_{GT} × 2.0

Note 2: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook (“Handling Precautions”/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

ELECTRICAL CHARACTERISTICS (Ta = 25°C)

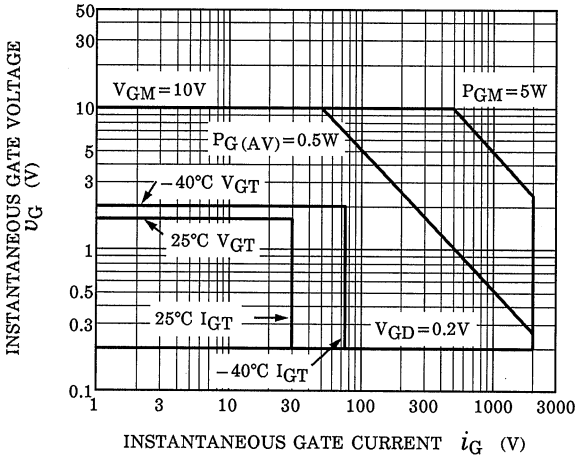
CHARACTERISTIC		SYMBOL	TEST CONDITION		MIN	TYP.	MAX	UNIT
Repetitive Peak Off−State Current		I_{DRM}	V_{DRM} = Rated		—	—	20	μA
Gate Trigger Voltage	I	V_{GT}	V_D = 12V, R_L = 20Ω	T2 (+) , Gate (+)	—	—	1.5	V
	II			T2 (+) , Gate (−)	—	—	1.5	
	III			T2 (−) , Gate (−)	—	—	1.5	
Gate Trigger Current	I	I_{GT}	V_D = 12V, R_L = 20Ω	T2 (+) , Gate (+)	—	—	30	mA
	II			T2 (+) , Gate (−)	—	—	30	
	III			T2 (−) , Gate (−)	—	—	30	
Peak On−State Voltage		V_{TM}	I_{TM} = 40A		—	—	1.5	V
Gate Non−Trigger Voltage		V_{GD}	V_D = Rated, Tc = 125°C		0.2	—	—	V
Holding Current		I_H	V_D = 12V, I_{TM} = 1A		—	—	60	mA
Thermal Resistance		$R_{th\ (j-c)}$	Junction to Case, AC		—	—	1.3	°C / W
Critical Rate of Rise of Off−State Voltage		dv / dt	V_{DRM} = Rated, T_j = 125°C Exponential Rise		—	300	—	V / μs
Critical Rate of Rise of Off−State Voltage at Commutation		(dv / dt) c	V_{DRM} = 400V, T_j = 125°C (di / dt) c = − 15A / ms		10	—	—	V / μs

MARKING

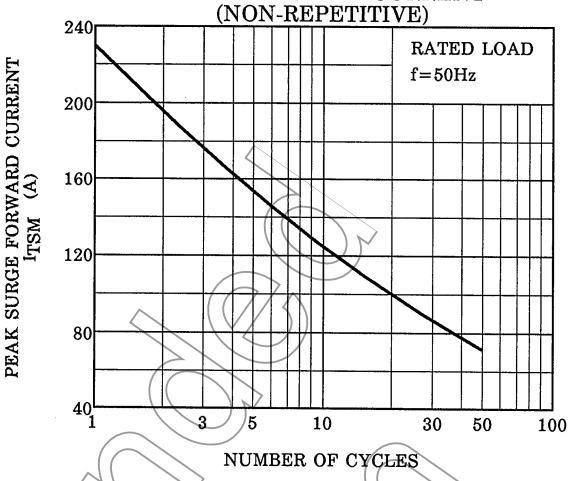


*1	Part No. (or abbreviation code)	Part No.
	M25GZ51	SM25GZ51
	M25JZ51	SM25JZ51

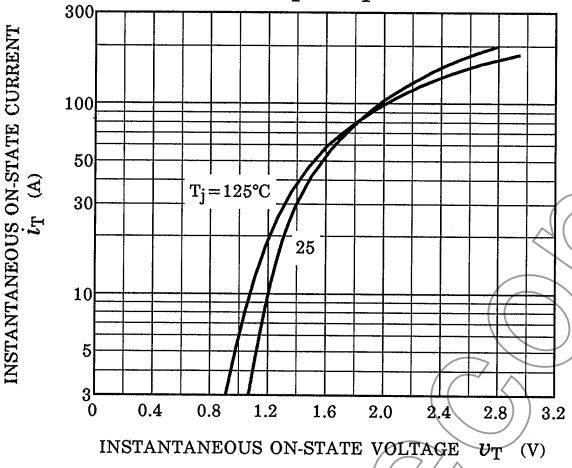
GATE TRIGGER CHARACTERISTIC



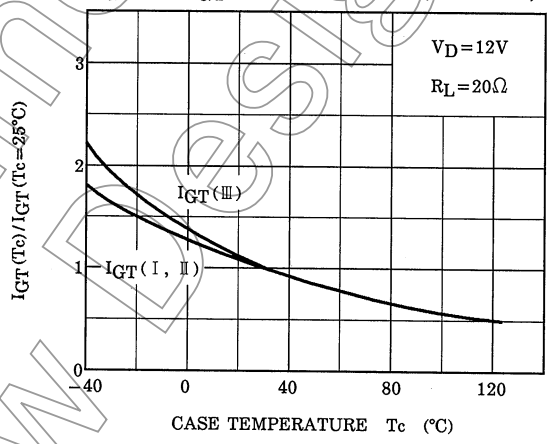
SURGE ON-STATE CURRENT
(NON-REPETITIVE)



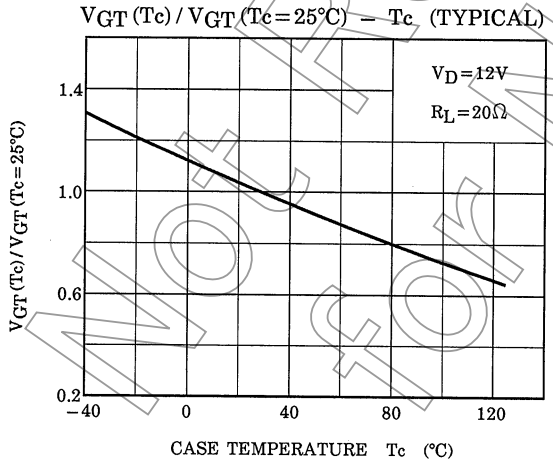
$i_T - v_T$



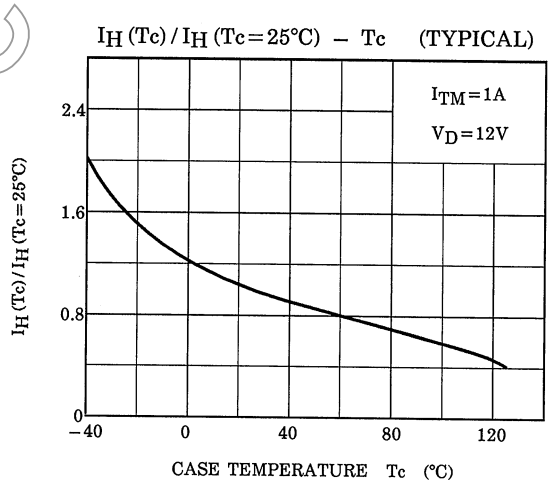
$I_{GT}(Tc) / I_{GT}(Tc=25°C)$ – Tc (TYPICAL)



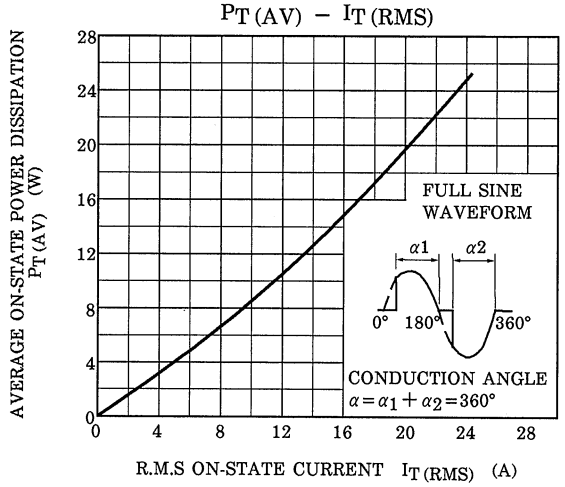
$V_{GT}(Tc) / V_{GT}(Tc=25°C)$ – Tc (TYPICAL)



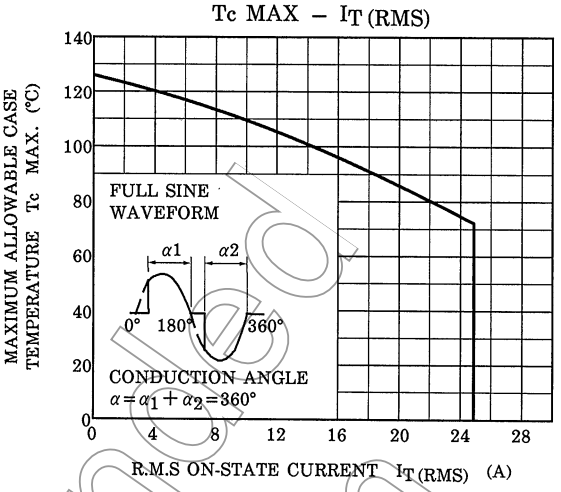
$I_H(Tc) / I_H(Tc=25°C)$ – Tc (TYPICAL)



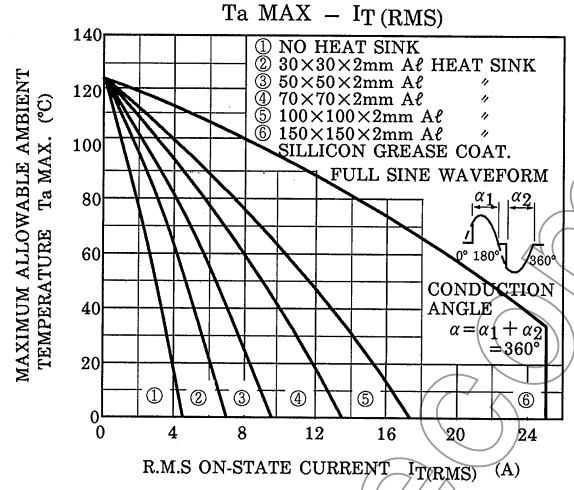
$P_{T(AV)}$ – $I_{T(RMS)}$



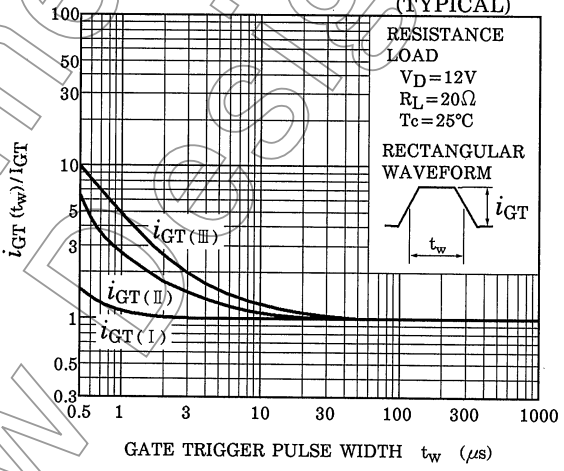
Tc MAX – $I_{T(RMS)}$



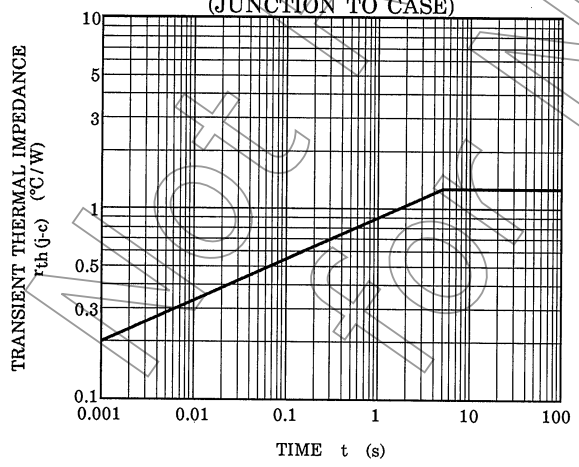
Ta MAX – $I_{T(RMS)}$



PULSE TRIGGER CHARACTERISTIC (TYPICAL)



TRANSIENT THERMAL IMPEDANCE (JUNCTION TO CASE)



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